
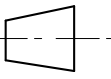



A		W31/2020	
indice	Description		Date
Contrôle par :		Autorise par:	
 ON semiconductor		Definition ASSEMBLY DRAWING BOTTOM PLAN EQUIPEMENT SOUDURE	 
		Subc. <b>DYPE</b> TECH	Dessine: e B
Board: <b>NCP1655 A TLS</b>		Echelle: 1/1	Pages: 3/3
CE DOCUMENT EST LA PROPRIETE DE ON semiconductor IL NE PEUT ETRE UTILISER, REPRODUIT OU COMMUNIQUER SANS SONT AUTHORISATION		Format: A3	
THIS DOCUMENT IS ON semiconductor PROPERTY, IT MAY NOT BE USED, REPRODUCED OR TRANSMITTED WITHOUT THEIR APPROVAL			